

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	2	("6634924").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2005/04/20 14:32
L2	11328	wafer near8 damage	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/04/20 14:32
L3	2146903	wafer or substrate	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/04/20 14:33
L4	44349	l3 with damage	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/04/20 14:34
L5	13106	l3 with failure	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/04/20 14:35
L6	1577	(l4 or l5) with detect\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/04/20 14:36
L7	165394	l6 ad cmp	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/04/20 14:36
L8	90	l6 and cmp	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/04/20 15:02
L9	466	semiconductor with damage with detect\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/04/20 15:02